TOSHIBA Field Effect Transistor Silicon N Channel MOS Type (L²-π-MOSV)

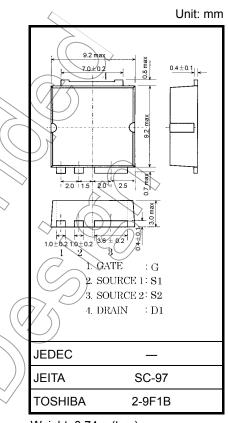
2SK3387

Switching Regulator, DC-DC Converter and Motor Drive Applications

- 4-V gate drive
- Low drain-source ON resistance: R_{DS} (ON) = 0.08 Ω (typ.)
- High forward transfer admittance: $|\rm Y_{fs}|$ = 17 S (typ.)
- Low leakage current: $I_{DSS} = 100 \ \mu A (V_{DS} = 150 \ V)$
- Enhancement mode: $V_{th} = 0.8 \sim 2.0 \text{ V} (V_{DS} = 10 \text{ V}, I_D = 1 \text{ mA})$

Absolute Maximum Ratings (Ta = 25°C)

Characteristics		Symbol	Rating	Unit	\geq	
Drain-source voltage		V _{DSS}	150	V		
Drain-gate voltage ($R_{GS} = 20 \text{ k}\Omega$)			V _{DGR}	150	y	
Gate-source voltage			V _{GSS}	±20	V	
Drain current	DC	(Note 1)	I _D	18	~ A	
Drain current	Pulse	(Note 1)	I _{DP}	54	~	(
Drain power dissipation (Tc = 25° C)			PD	100	W	_ `
Single pulse avalanche energy (Note 2)			Eas	176	mJ	
Avalanche current		IAR	18	A	_/	
Repetitive avalanche energy (Note 3)			EAR	10	mJ	Ň
Channel temperature				150 <	°C	
Storage temperature range			T _{stg}	-55~150)°C	



Weight: 0.74 g (typ.)

Note: Using continuously under heavy loads (e.g. the application of high temperature/current/voltage and the significant change in temperature, etc.) may cause this product to decrease in the reliability significantly even if the operating conditions (i.e. operating temperature/current/voltage, etc.) are within the absolute maximum ratings. Please design the appropriate reliability upon reviewing the Toshiba Semiconductor Reliability Handbook ("Handling Precautions"/Derating Concept and Methods) and individual reliability data (i.e. reliability test report and estimated failure rate, etc.).

Thermal Characteristics

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Characteristics	Symbol	Max	Unit
Thermal resistance, channel to case	Rth (ch-c)	1.25	°C/W

Note 1: Ensure that the channel/temperature does not exceed 150°C.

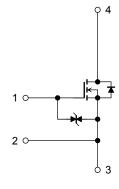
Note 2: V_{DD} = 50 V, T_{ch} = 25^eC (initial), L = 800 μ H, R_G = 25 Ω , I_{AR} = 18 A

Note 3: Repetitive rating: pulse width limited by max junction temperature

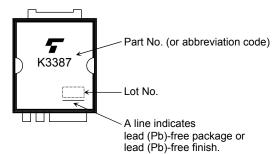
This transistor is an electrostatic-sensitive device. Please handle with caution.

Notice:

Please use the S1 pin for gate input signal return. Make sure that the main current flows into S2 pin.



Marking



Electrical Characteristics (Note 4) (Ta = 25°C)

Chara	acteristics	Symbol	Test Condition	Min	Тур.	Max	Unit
Gate leakage cur	rent	I _{GSS}	$V_{GS} = \pm 16 \text{ V}, \text{ V}_{DS} = 0 \text{ V}$	_	\square	±10	μA
Drain cut-off curre	ent	I _{DSS}	$V_{DS} = 150 \text{ V}, \text{ V}_{GS} = 0 \text{ V}$		47	100	μA
Drain-source brea	akdown voltage	V (BR) DSS	$I_D = 10 \text{ mA}, V_{GS} = 0.0 \text{ M}$	150	$\leq - \langle$	> —	V
Gate threshold vo	oltage	V _{th}	$V_{DS} = 10 V, I_D = 1 mA$	0.8		2.0	V
Drain-source ON	resistance	R _{DS (ON)}	$V_{GS} = 4 V, P = 9 A$ $V_{GS} = 10 V, P = 9 A$	$\overline{2}$	0.09	0.18	Ω
Forward transfer	admittance	Y _{fs}	$V_{DS} = 10 \text{ V}, \text{ I}_D = 9 \text{ A}$	10	17	_	S
Input capacitance)	C _{iss}		Z	1380	_	
Reverse transfer	capacitance	C _{rss}	$N_{DS} = 10 V$, $V_{GS} = 0 V$, $f = 1 MHz$)	200	_	pF
Output capacitan	се	C _{oss} <			610	_	
Switching time	Rise time	tr	VGS1 ID ≥9A VOUT		12		
	Turn-on time	ton	$G \circ G \circ H = 11 \Omega$		20		ns
	Fall time		Store Store		12		115
	Turn-off time	toff	$Duty \leqq 1\%, t_W = 10 \ \mu s$		68		
Total gate charge gate-drain)	e (gate-source plus	⊂ Q _g		_	57	_	nC
Gate-source char	ge	Qgs	V _{DD} ≥ 120 V, V _{GS} = 10 V, I _D = 18 A	_	43	—	nC
Gate-drain ("mille	r") charge	Q _{gd}		—	14	—	nC

Note 4: Connect the S1 and S2 pins together, and ground them except during switching time measurement.

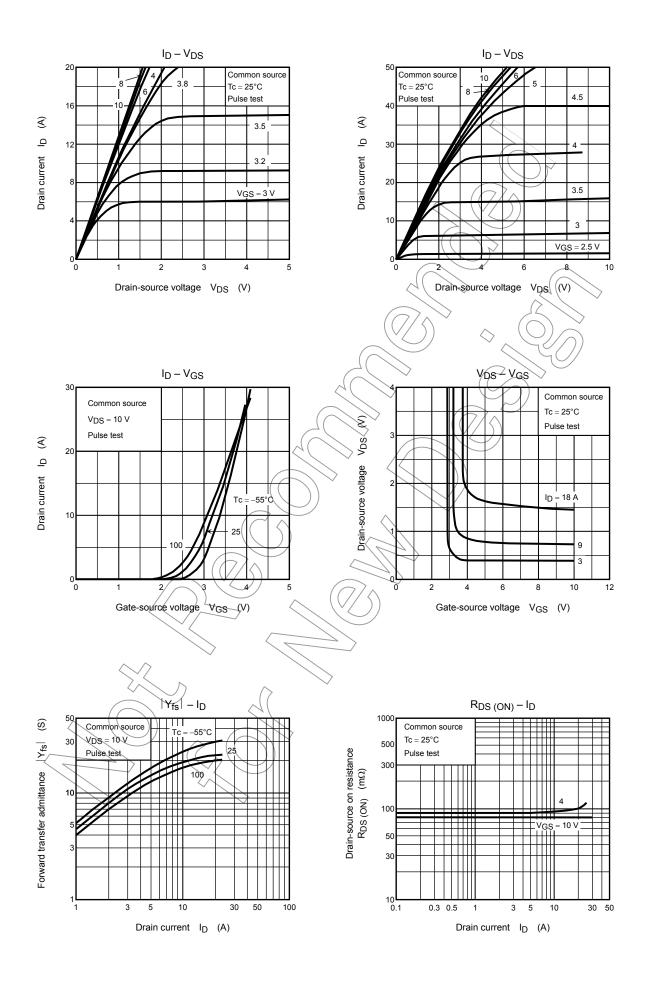
Source-Drain Diode Ratings and Characteristics (Note 5) (Ta = 25° C)

Characteristics	\bigcirc	Symbol	Test Condition	Min	Тур.	Max	Unit
Continuous drain reverse current (Note	1, 5)	I _{DR} 1	—	—	_	18	А
Pulse drain reverse current (Note	e 1, 5)	I _{DRP} 1	—	_	_	54	А
Continuous drain reverse current (Note	e 1, 5)	I _{DR} 2	—	_	_	1	А
Pulse drain reverse current (Note	e 1, 5)	I _{DRP} 2	—	_	_	4	А
Diode forward voltage		V _{DS2F}	I _{DR1} = 18 A, V _{GS} = 0 V	_	_	-1.7	V
Reverse recovery time		t _{rr}	$I_{DR} = 18 \text{ A}, V_{GS} = 0 \text{ V},$	_	185	_	ns
Reverse recovery charge		Q _{rr}	dl _{DR} /dt = 100 A/µs		1.3	_	μC

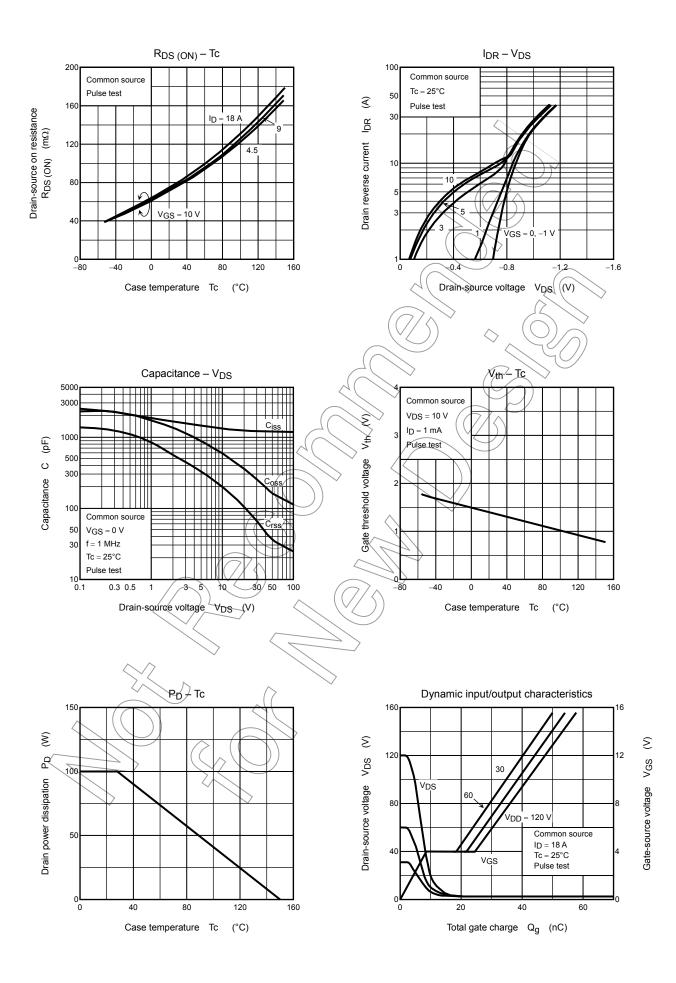
Note 5: I_{DR}1, I_{DRP}1:Current flowing between the drain and the S2 pin. Ensure that the S1 pin is left open. I_{DR}2, I_{DRP}2:Current flowing between the drain and the S1 pin. Ensure that the S2 pin is left open.

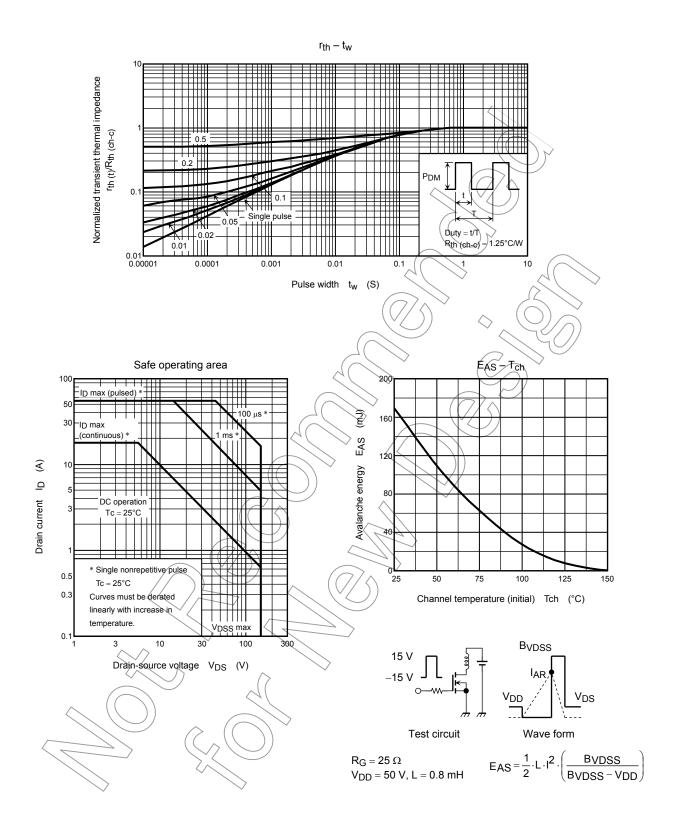
Unless otherwise specified, connect the S1 and S2 pins together, and ground them

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